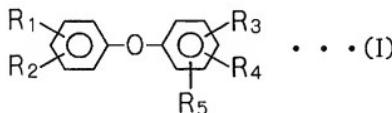


## AMENDMENTS TO THE CLAIMS

**1. (Currently Amended)** A developer composition for resists, comprising an organic quaternary ammonium base as a main component,

said developer composition further comprising an anionic surfactant represented by the following general formula (I):



wherein at least one of R<sub>1</sub> and R<sub>2</sub> represents an alkyl or alkoxy group having 5 to 18 carbon atoms and the other one represents a hydrogen atom, or an alkyl or alkoxy group having 5 to 18 carbon atoms, and at least one of R<sub>3</sub>, R<sub>4</sub> and R<sub>5</sub> represents an ammonium sulfonate group or a sulfonic acid-substituted ammonium group and the others represent a hydrogen atom, an ammonium sulfonate group or a sulfonic acid-substituted ammonium group, and;

$\text{SO}_4^{2-}$ , the content being in an amount from 10 to 10,000 ppm; and a lower alcohol in an amount from 0.05 to 2.5% by mass.

**2. (Canceled)**

**3. (Amended)** The developer composition for resists according to claim 1, further comprising a halogen ion, the content being in an amount of 1000 ppm or less.

**4. (Previously presented)** A method for formation of a resist pattern, comprising applying a resist composition on a substrate to form a resist layer, prebaking the resist layer, selectively exposing the prebaked resist layer to light, and alkali-developing the exposed resist layer with the developer composition for resists according to claim 1 to form a resist pattern.

5. (New) The developer composition for resists according to claim 1, wherein said lower alcohol has 1 to 5 carbon atoms.

6. (New) The developer composition for resists according to claim 5, wherein the lower alcohol is ethanol or methanol.